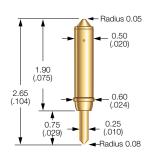
Semiconductor Probes 0.80мм Рітсн

623-0271 PROBE





PROBE SPECIFICATIONS

Minimum Device Pitch: 0.80mm (.031) Signal Path Length: 2.15mm (0.085)

Force per Contact: 27.5g (0.97 oz.) @ 0.50mm (.020) travel

Device Compliance: 0.30mm (.012) DUT Board Compliance: 0.20mm (.008) Operating Temperature: -55°C to 120°C

Insertions: > 500,000

MATERIALS

Barrel: Phosphorous bronze, gold plating

Spring: Music wire, gold plated

Device Side Contact: Carbon steel, gold plated

Board Side Contact: Full-hard beryllium copper, gold plated

ELECTRICAL SPECIFICATIONS

Typical Resistance: < 40 mΩ

Current Carrying Capacity: 3 amps continuous (Current DC carry capability @ 80° C steady state)

Pattern 2a: R S R @ 1.0 mm pitch Characteristic Impedance: 54 Ω

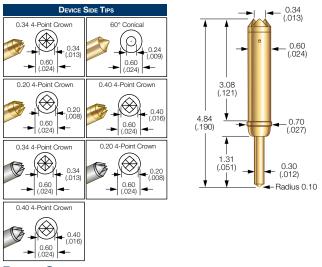
Time Delay: 13 pSec Loop Inductance: 0.72 nH

Signal Pin to Return Capacitance: 0.25 pF -1 dB Insertion Loss Bandwidth: > 20 GHz

How to Order			
Part No.	Device Side Tip	PCB Side Tip	
623-0271-01	Conical	Conical	

Prolonged exposure of greater than one hour reduces the maximum operating temperature of music wire springs to 85°C.

623-0195 PROBE



PROBE SPECIFICATIONS

Minimum Device Pitch: 0.80mm (.031) Signal Path Length: 4.04mm (.159)

Force per Contact: 33.4g (1.18 oz.) @ 0.80mm (.031) travel

Device Compliance: 0.50mm (.020) DUT Board Compliance: 0.30mm (.012) Operating Temperature: -55°C to 120°C

(Higher operating temperature probes available, consult factory)

Insertions: > 500,000

MATERIALS

Barrel: Phosphorous bronze, gold plating

Spring: Music wire, gold plated

Device Side Contact:

02 & 03 Carbon steel, gold plated

08 & 09 Full-hard beryllium copper, gold plated

H2, H8, & H9 Homogeneous alloy

Board Side Contact: Full-hard beryllium copper, gold plated

ELECTRICAL SPECIFICATIONS

Typical Resistance: $03 < 35 \text{ m}\Omega$: 02, 08, 09, H2, H8, & H9 < 50 m Ω

Carrying Capacity: 3 amps continuous (Current DC carry capability @ 80° C steady state)

Pattern 2a: R S R @ 0.8mm pitch Characteristic Impedance: 37 \, \Omega

Time Delay: 23 pSec Loop Inductance: 0.86 nH

Signal Pin to Return Capacitance: 0.62 pF -1 dB Insertion Loss Bandwidth: > 20 GHz

How to Order		
Part No.	Device Side Tip	PCB Side Tip
623-0195-02	0.34 4-pt. Crown	Conical
623-0195-03	Conical	Conical
623-0195-08	0.20 4-pt. Crown	Conical
623-0195-09	0.40 4-pt. Crown	Conical
623-0195-H2	0.34 4-pt. Crown	Conical
623-0195-H8	0.20 4-pt. Crown	Conical
623-0195-H9	0.40 4-pt. Crown	Conical

H2, H8 & H9 has the homogeneous alloy on the device side of the contact.

Specifications subject to change without notice. Dimensions in millimeters (inches)